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INFORMATION DISCLOSURE STATEMENT					APPLICANT(S): Card et al.						
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			FILING DATE: 9/5/03 GROUP: Not yet assigned								
U.S. PATENT DOCUMENTS											
EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME			CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
WB	Al	5,467,883	11/21/95	Frye et al.			216	60	11/27/93		
QB	· A2	5,559,690	9/24/96	Keeler et al.			364	164 44	9/16/94		
CUB	A3	5,654,903	8/5/97	Reitman et al.			364702	254.0J	11/7/95		
CJB	A4	5,740,033	4/14/98	Wassick e	t al.		364-700	14529	10/13/92		
CUB	A5	6,268,226	7/31/01	Angell et a	Angell et al.		438	16	6/30	6/30/99	
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		·	FOREI	GN PATE	NT DOCU	MENTS					
EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTR/ ONLY	CT	ENGLISH LANG (Y/N)	
CODA	Bi	WO-01/57605	-8/9/01	-wo	G05B	-13/04	-1/1-1/01-	-N		-ү	
(7)	B2	DE196 37 917 A1	3/19/98	DE	G05B	13/04	9/17/96	Y			
i 	<u> </u>	L	THER A	RT, JOURN	JAL ARTI	CLES, E	TC.		•		
EXAM. INIT.	OTHER ART, JOURNAL ARTICLES, ETC.  OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)										
CSB	СІ	Card et al., "Dynamic Neural Control for Plasma Etch Process," <u>IEEE Transactions on Neural Networks</u> , (1997).									
QB	C2	Card et al., "Impacts of Maintenance Input on the Prediction Accuracy of an APC Controller," Presentation at AEC/APC Symposium XIV (September 9-11, 2002).									
WB	C3	Card et al., "Advanced Analysis of Dynamic Neural Control Advisories for Process Optimization and Parts Maintenance," Presentation at AEC/APC Symposium XIV (September 9-11, 2002).									
QB	C4	Dillon et al., "Guest Editorial Everyday Applications of Neural Networks," <u>IEEE Transactions on Neural Networks</u> , 8:4 (July 1997).									
UB	C5	Hatzipantelis et al., "Comparing Hidden Markov Models with Artificial Neural Network Architectures for Condition Monitoring Applications," <u>Artificial Neural Networks</u> , 26-28, Conference Publication No. 409 (June 1995).									

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CUB	C6	Kim et al., "Intelligent Control of Via Formation by Photosensitive BCB for MCM-L/D Applications," <u>IEEE Transactions on Semiconductor Manufacturing</u> , 12:503 (1999).					
CUB	C7	Konstantopoulos et al., "Controllers with Diagnostic Capabilities. A Neural Network Implementation.  Journal of Intelligent and Robotic Systems," Department of Electrical Engineering, University of Notre  Dame, IN 12: 197-228 (1995).					
CJ3	C8	Moyne, "AEC/APC Vision: A Research and Suppliers' Point of View," 3 <sup>rd</sup> Annual European AEC/APC Conference Proceedings (2002).					
WB	C9	Rietman et al., "A Study on $\mathfrak{R}^m \to \mathfrak{R}^1$ Maps: Application to a 0.16- $\mu$ m Via Etch Process Endpoint," IEEE (2000).					
CSB	C10	Rietman et al., "A System Model for Feedback Control and Analysis of Yield: A Multistep Process Model of Effective Gate Length, Poly Line Width, and IV Parameters", <u>IEEE</u> (2001).					
CUB	· C11	Rietman, "Neural Networks in Plama Processing," <u>Journal of Vacuum Science and Technology: Part B, IEEE Transactions on Semiconductor Manufacturing</u> , 14:1 (2001).					
CUB	C12	Smyth et. al., "Hidden Markov Models an Neural Networks for Fault detection in Dynamic Systems," California Institute of Technology (1993).					
CB	C13	Zhang et al, "Control of Spatial Uniformity in Microelectronics Manufacturing: An Integrated Approach," Proceedings of AEC/APC (2000).					
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EXAMIN	ER (	Just al Burned Date Considered 26 April 2005					